

D0816-01 Information

Heisener.com

Part Number D0816-01

Manufacturer Harwin Inc.

Category Connectors, Interconnects Sockets for ICs, Transistors

Description CONN IC DIP SOCKET 16POS GOLD

Package -

For the pricing/inventory/lead time, please contact

us

For Reference Only

Website: https://www.heisener.com
E-mail: salesdept@heisener.com



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Certified Quality

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D0816-01 Specifications

Manufacturer Part Number Manufacturer Category Connectors, Interconnects Sockets for ICs, Transistors Package Series D0 Type DIP, 0.3" (7.62mm) Row Spacing Number of Positions or Pins (Grid) 16 (2 x 8) Pitch - Mating O.100" (2.54mm) Contact Finish - Mating Contact Material - Mating Beryllium Copper Mounting Type Through Hole Features Open Frame Termination Wire Wrap Pitch - Post O.100" (2.54mm) Contact Finish - Post Tin Contact Finish - Post Tin Contact Finish Thickness - Post D196.8µin (5.00µm) Brass Polycyclohexylenedimethylene Terephthalate (PCT), Glass Filled Operating Temperature Prepart errors? Prepart errors?	*		
Category Connectors, Interconnects Sockets for ICs, Transistors Package - Series D0 Type DIP, 0.3" (7.62mm) Row Spacing Number of Positions or Pins (Grid) 16 (2 x 8) Pitch - Mating 0.100" (2.54mm) Contact Finish - Mating Gold Contact Finish Thickness - Mating 10μin (0.25μm) Contact Material - Mating Beryllium Copper Mounting Type Through Hole Features Open Frame Termination Wire Wrap Pitch - Post 0.100" (2.54mm) Contact Finish - Post Tin Contact Finish Thickness - Post 196.8μin (5.00μm) Contact Material - Post Brass Housing Material Polycyclohexylenedimethylene Terephthalate (PCT), Glass Filled Operating Temperature -55°C ~ 125°C	Manufacturer Part Number	D0816-01	
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Operating Temperature $-55^{\circ}\text{C} \sim 125^{\circ}\text{C}$	Contact Material - Post	Brass	
	Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Glass Filled	
Report errors?	Operating Temperature	-55°C ~ 125°C	
Report cross:			Report errors?

D0816-01 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

D0816-01 Payment Methods





















D0816-01 Shipping Methods













If you have any question about D0816-01, please do not hesitate to contact us!

Website: https://www.heisener.com E-mail: salesdept@heisener.com